

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the INVENTION ENTITLED CVD APPARATUS, ITS PURGING METHOD, METHOD FOR JUDGING MAINTENANCE TIMES OF SEMICONDUCTOR PRODUCTION APPARATUSES, MOISTURE
the specification of which (CHECK applicable BOX(ES)) MONITORING APPARATUS AND SEMICONDUCTOR PRODUCTION
-> ☒ is attached hereto.
-> ☐ was filed on _____ as U.S. Application No. 0 / _____
BOX(ES) -> ☐ was filed as PCT International Application No. PCT/ _____ on _____
-> and (if applicable to U.S. or PCT application) was amended on _____

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. 1.56. I hereby claim foreign priority benefits under 35 U.S.C. 119/365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate filed by me or my assignee disclosing the subject matter claimed in this application and having a filing date (1) before that of the application on which priority is claimed, or (2) if no priority claimed, before the filing date of this application:

PRIOR FOREIGN APPLICATION(S)	Date first Laid- open or Published	Date Patented or Granted	Priority Claimed Yes No
Patent 11-246240 Japan 31/08/1999			Yes
P2000-052555 Japan 28/02/2000			Yes
P2000-052516 Japan 28/02/2000			Yes

I hereby claim domestic priority benefit under 35 U.S.C. 120/365 of the indicated United States applications listed below and PCT international applications listed above or below and, if this is a continuation-in-part (CIP) application, insofar as the subject matter disclosed and claimed in this application is in addition to that disclosed in such prior applications. I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. 1.56 which became available between the filing date of each such prior application and the national or PCT international filing date of this application:

PRIOR U.S. PROVISIONAL, NONPROVISIONAL AND/OR PCT APPLICATION(S)	Status	Priority Claimed Yes No
Application No. (series code/serial no.)	Day/MONTH/Year Filed	pending, abandoned, patented

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

And I hereby appoint Cushman Darby & Cushman Intellectual Property Group of Pillsbury Madison & Sutro LLP, 1100 New York Avenue, N.W., Ninth Floor, East Tower, Washington, D.C. 20005-3918, telephone number (202) 861-3000 (to whom all communications are to be directed), and the below-named persons (of the same address) individually and collectively my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, and I hereby authorize them to delete names/numbers below of persons no longer with their firm and to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct the above Firm and/or a below attorney in writing to the contrary.

Paul N. Kokulis	16773	David W. Brinkman	20817	Chris Comenetz	31097	David A. Jakopin	32995
Raymond F. Lippitt	17519	George M. Sirilla	18221	Lawrence Harbin	24644	Mark G. Paulson	30793
G. Lloyd Knight	17698	Donald J. Bird	25323	Paul E. White, Jr.	32011	James D. Berquist	34256
Carl G. Bero	18751	W. Warren Takavich	26577	Michelle N. Lester	32331	Timothy J. Kluna	34852
Eduard H. Martin	20334	Peter W. Gowdey	25872	Joseph A. Simonian	34993	John P. Moran	30906
William K. West, Jr.	22057	Dale S. Lazar	28872			Stephen C. Glazier	31361
Kevin E. Joyce	20508	Glenn J. Perry	28458	G. Paul Edgell	24238	Paul F. McQuade	34542
Edward M. Prince	22429	Kendrew H. Colton	30368	Lynn E. Eccleston	35861		

1. INVENTOR'S SIGNATURE: Hiroyuki Hasegawa Date August 3, 2000
Inventor's Name (typed) Hiroyuki Hasegawa Japan
Residence (City) Tokyo (State/Foreign Country) Japan
Post Office Address (Include Zip Code) c/o Mitsubishi Materials Silicon Corporation, 5-1, Otemachi 1-chome, Chiyoda-ku, Tokyo, Japan

2. INVENTOR'S SIGNATURE: Tomonori Yamaoka Date August 3, 2000
Inventor's Name (typed) Tomonori Yamaoka Japan
Residence (City) Tokyo (State/Foreign Country) Japan
Post Office Address (Include Zip Code) c/o Mitsubishi Materials Silicon Corporation, 5-1, Otemachi 1-chome, Chiyoda-ku, Tokyo, Japan

3. INVENTOR'S SIGNATURE: Yoshio Ishihara Date August 3, 2000
Inventor's Name (typed) Yoshio Ishihara Japan
Residence (City) Tokyo (State/Foreign Country) Japan
Post Office Address (Include Zip Code) c/o NIPPON SANSEI CORPORATION, 16-7, Nishi-shinbashi 1-chome, Minato-ku, Tokyo, Japan

(FOR ADDITIONAL INVENTORS, check box ☒ and attach sheet (CDC-116.2) for same information for each re signature, name, date, citizenship, residence and address.)

DECLARATION AND POWER OF ATTORNEY

(continued)

ADDITIONAL INVENTORS:

4. INVENTOR'S SIGNATURE: Hiroshi Masusaki Date August 3, 2000Inventor's Name (typed) Hiroshi Masugaki Japan

First

Middle Initial

Family Name Country of Citizenship

Residence (City) Tokyo (State/Foreign Country) JapanPost Office Address (Include Zip Code) c/o NIPPON SANSO CORPORATION, 16-7, Nishi-shinbashi
1-chome, Minato-ku, Tokyo, Japan5. INVENTOR'S SIGNATURE: Takayuki Satou Date August 3, 2000Inventor's Name (typed) Takayuki Satou Japan

First

Middle Initial

Family Name Country of Citizenship

Residence (City) Tokyo (State/Foreign Country) JapanPost Office Address (Include Zip Code) c/o NIPPON SANSO CORPORATION, 16-7, Nishi-shinbashi
1-chome, Minato-ku, Tokyo, Japan6. INVENTOR'S SIGNATURE: Katsumasa Suzuki Date August 3, 2000Inventor's Name (typed) Katsumasa Suzuki Japan

First

Middle Initial

Family Name Country of Citizenship

Residence (City) Tokyo (State/Foreign Country) JapanPost Office Address (Include Zip Code) c/o NIPPON SANSO CORPORATION, 16-7, Nishi-shinbashi
1-chome, Minato-ku, Tokyo, Japan7. INVENTOR'S SIGNATURE: Hiroki Tokunaga Date August 3, 2000Inventor's Name (typed) Hiroki Tokunaga Japan

First

Middle Initial

Family Name Country of Citizenship

Residence (City) Tokyo (State/Foreign Country) JapanPost Office Address (Include Zip Code) c/o NIPPON SANSO CORPORATION, 16-7, Nishi-shinbashi
1-chome, Minato-ku, Tokyo, Japan

8. INVENTOR'S SIGNATURE: _____ Date _____

Inventor's Name (typed) _____

First

Middle Initial

Family Name Country of Citizenship

Residence (City) _____ (State/Foreign Country) _____

Post Office Address (Include Zip Code) _____

9. INVENTOR'S SIGNATURE: _____ Date _____

Inventor's Name (typed) _____

First

Middle Initial

Family Name Country of Citizenship

Residence (City) _____ (State/Foreign Country) _____

Post Office Address (Include Zip Code) _____

FOR ADDITIONAL INVENTORS, check box ☐ and attach sheet with same information and signature and date for each.